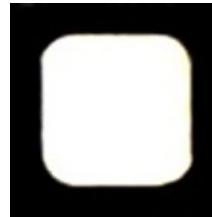


**Silicon Carbide Power
Schottky Diode Chip**
Features

- 1200 V Schottky rectifier
- 250 °C maximum operating temperature
- Temperature independent switching behavior
- Superior surge current capability
- Positive temperature coefficient of V_F
- Extremely fast switching speeds
- Superior figure of merit Q_C/I_F


Maximum Ratings at $T_j = 250$ °C, unless otherwise specified

Parameter	Symbol	Conditions	Values	Unit
Repetitive peak reverse voltage	V_{RRM}		1200	V
Continuous forward current	I_F	$T_C \leq 205$ °C	20	A
RMS forward current	$I_{F(RMS)}$	$T_C \leq 205$ °C	35	A
Operating and storage temperature	T_j, T_{stg}		-55 to 250	°C

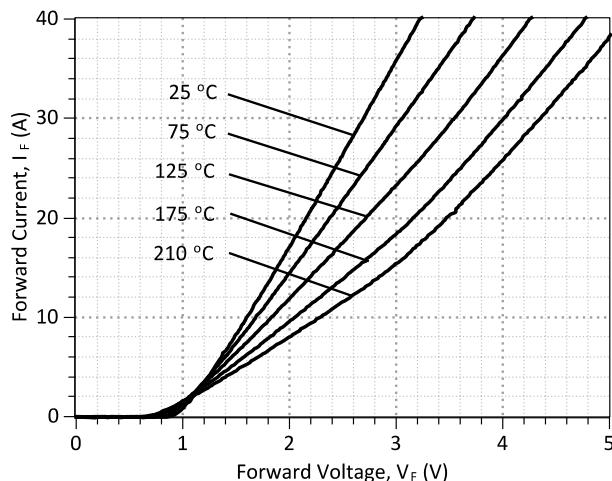
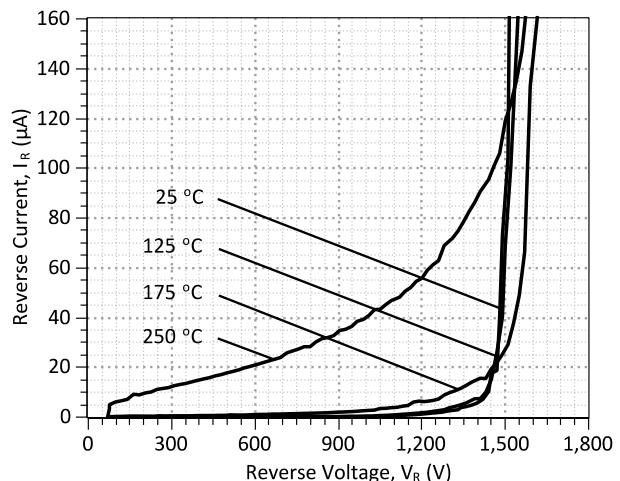
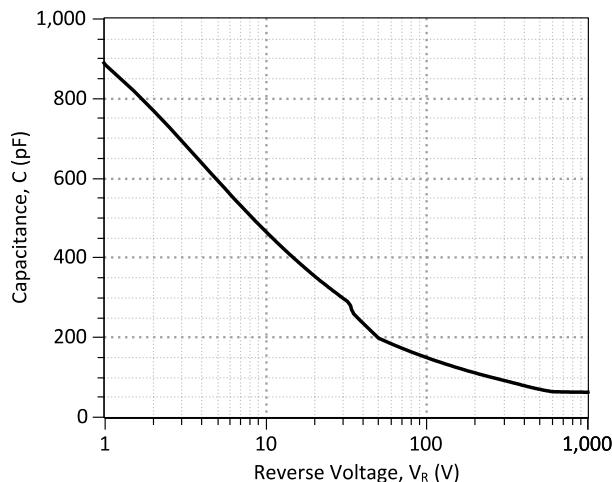
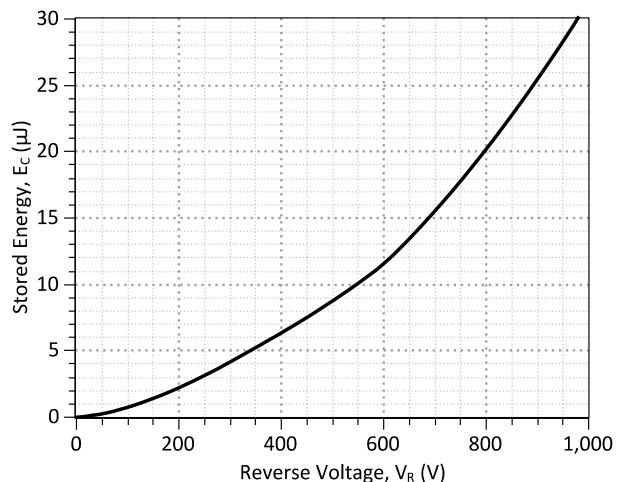
Electrical Characteristics at $T_j = 250$ °C, unless otherwise specified

Parameter	Symbol	Conditions	Values			Unit
			min.	typ.	max.	
Diode forward voltage	V_F	$I_F = 20$ A, $T_j = 25$ °C	2.2			V
		$I_F = 20$ A, $T_j = 210$ °C	3.5			
Reverse current	I_R	$V_R = 1200$ V, $T_j = 25$ °C	1.2	20		μ A
		$V_R = 1200$ V, $T_j = 250$ °C	56	300		
Total capacitive charge	Q_C	$I_F \leq I_{F,MAX}$	$V_R = 400$ V $V_R = 960$ V	58 95		nC
		$dI_F/dt = 200$ A/ μ s $T_j = 210$ °C	$V_R = 400$ V $V_R = 960$ V	< 49		
Switching time	t_s					ns
Total capacitance	C	$V_R = 1$ V, $f = 1$ MHz, $T_j = 25$ °C	884			pF
		$V_R = 400$ V, $f = 1$ MHz, $T_j = 25$ °C	79			
		$V_R = 1000$ V, $f = 1$ MHz, $T_j = 25$ °C	63			

Thermal Characteristics

Thermal resistance, junction - case	R_{thJC}	Assuming TO-276 package	0.49	°C/W
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*For chip size and metallization, please refer to the mechanical datasheet (must have a non-disclosure agreement with GeneSiC Semiconductor).


Figure 1: Typical Forward Characteristics

Figure 2: Typical Reverse Characteristics

Figure 3: Typical Junction Capacitance vs Reverse Voltage Characteristics

Figure 4: Typical Switching Energy vs Reverse Voltage Characteristics

Revision History			
Date	Revision	Comments	Supersedes
2012/04/03	0	Initial release	

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 43670 Trade Center Place Suite 155
 Dulles, VA 20166

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SPICE Model Parameters

Copy the following code into a SPICE software program for simulation of the GB20SHT12-CAL device.

```
* MODEL OF GeneSiC Semiconductor Inc.
*
* $Revision: 1.0      $
* $Date: 05-SEP-2013  $
*
* GeneSiC Semiconductor Inc.
* 43670 Trade Center Place Ste. 155
* Dulles, VA 20166
* http://www.genesicsemi.com/index.php/sic-products/schottky
*
* COPYRIGHT (C) 2013 GeneSiC Semiconductor Inc.
* ALL RIGHTS RESERVED
*
* These models are provided "AS IS, WHERE IS, AND WITH NO WARRANTY
* OF ANY KIND EITHER EXPRESSED OR IMPLIED, INCLUDING BUT NOT LIMITED
* TO ANY IMPLIED WARRANTIES OF MERCHANTABILITY AND FITNESS FOR A
* PARTICULAR PURPOSE."
* Models accurate up to 2 times rated drain current.
*
* Start of GB20SHT12-CAL SPICE Model
*
.SUBCKT GB20SHT12 ANODE KATHODE
D1 ANODE KATHODE GB20SHT12_25C; Call the Schottky Diode Model
D2 ANODE KATHODE GB20SHT12_PIN; Call the PiN Diode Model
.MODEL GB20SHT12_25C D
+ IS      1.74E-13      RS      0.05105
+ TRS1    0.005        TRS2    1.68E-5
+ N       1.2637323    IKF     1.884319
+ EG      1.2          XTI     3
+ CJO     1.15E-09     VJ      0.44
+ M       1.5          FC      0.5
+ TT      1.00E-10     BV      1500
+ IBV     1.00E-03     VPK     1200
+ IAVE    20           TYPE    SiC_Schottky
+ MFG     GeneSiC_Semiconductor
.MODEL GB20SHT12_PIN D
+ IS      5.15E-15      RS      0.2
+ N       3.1605        IKF     0.000055844
+ EG      3.23          XTI     3
+ FC      0.5           TT      0
+ BV      1500          IBV     1.00E-03
+ VPK     1200          IAVE    20
+ TYPE    SiC_PiN
.ENDS
*
* End of GB20SHT12-CAL SPICE Model
```

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